



## MJ N-Channel Enhancement Mode Power MOSFET

### Description

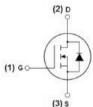
The MJ0128D uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. It can be used in a wide variety of applications.

#### General Features

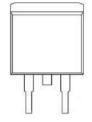
- ♦ Vps =100V.lp =28A  $R_{\text{DS(ON)}} < 18 \text{m}\Omega$  @  $V_{\text{GS}} = 10 \text{V}$  (Typ:14m $\Omega$ )
- ◆ Special process technology for high ESD capability
- ♦ High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E<sub>AS</sub>
- ◆ Excellent package for good heat dissipation

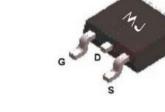
### Application

- ◆ Power switching application
- Hard switched and High frequency circuits
- ◆ Uninterruptible power supply









Schematic diagram

Marking and pin assignment

TO-263-2L top view

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ0128D	MJ0128D	TO-263-2L	ii ii	-	9

### Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lD	28	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	20	А
Pulsed Drain Current	Ірм	160	А
Maximum Power Dissipation	PD	150	W
Derating factor		1	W/°C
Single pulse avalanche energy (Note 5)	Eas	550	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	2.4	°C/W
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# Electrical Characteristics (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVpss	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	100	110	-	V
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	2	3.2	4	V
Drain-Source On-State Resistance	RDS(ON)	V <sub>GS</sub> =10V, I <sub>D</sub> =16A	-	14	18	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =25V,I <sub>D</sub> =16A	30	-	-	S
Dynamic Characteristics (Note 4)	-	1				
Input Capacitance	Ciss		-	3700	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V F=1.0MHz	-	630	-	PF
Reverse Transfer Capacitance	Crss	•	-	330	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	12	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =50V,I <sub>D</sub> =16A	-	55	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	Vgs=10V,Rgen=2.5Ω	-	45	_	nS
Turn-Off Fall Time	t <sub>f</sub> - 47		-	nS		
Total Gate Charge	Qg		-	95	-	nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =80V,I <sub>D</sub> =16A V <sub>GS</sub> =10V	-	18	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	-	_	25		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsp	V <sub>GS</sub> =0V,I <sub>S</sub> =16A	_	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	57	А
Reverse Recovery Time	trr	T1-25°C 15-46A	-	140	220	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=16A di/dt=100A/µs (Note 3)	-	650	1000	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible(turn-on is dominated by L				

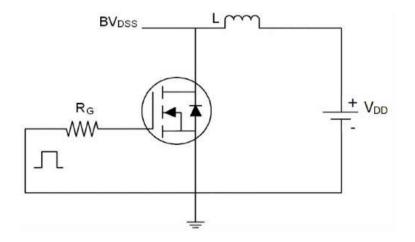
### Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- § EAS condition: Tj=25°C,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

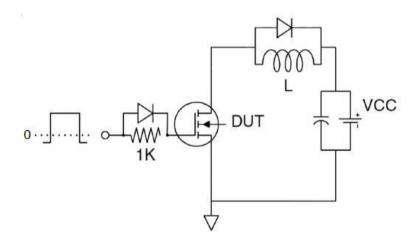




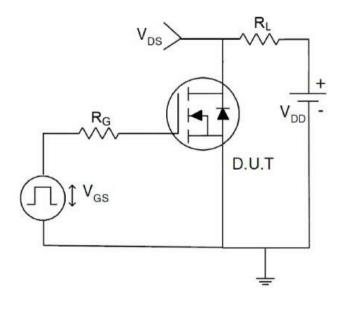
### Test circuit



Eas test Circuit



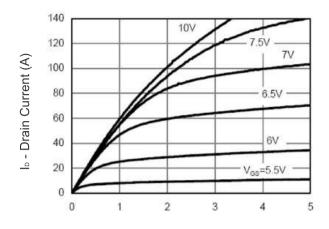
Gate charge test Circuit



Switch Time Test Circuit



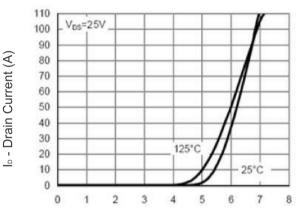
### Typical Electrical and Thermal Characteristics (Curves)



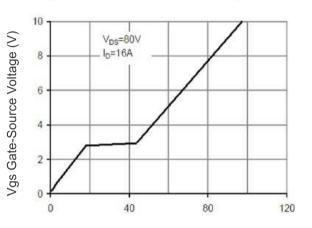
Normalized On-Resistance 1.8 V<sub>GS</sub>=10V, 16 A 1.6 1.4 1.2 1 0.8 0.6 25 50 75 100 125 150 175 -50

Vds Drain-Source Voltage (V)

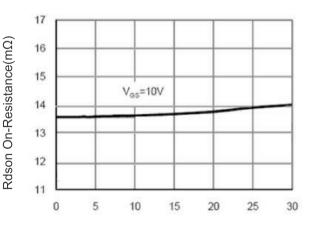
Figure 1 Output Characteristics



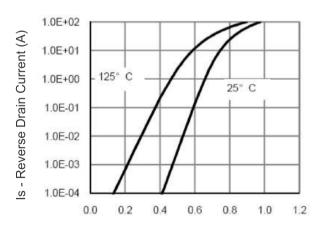
T<sub>J</sub> -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature



Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics



Qg Gate Charge (nC) Figure 5 Gate Charge



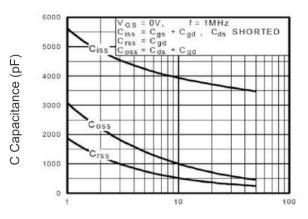
I<sub>D</sub> - Drain Current (A)

Figure 3 Rdson- Drain Current

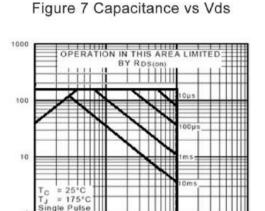
Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



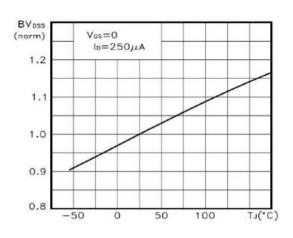
lo - Drain Current (A)



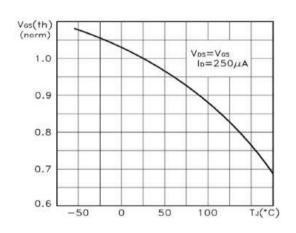
Vds Drain-Source Voltage (V)



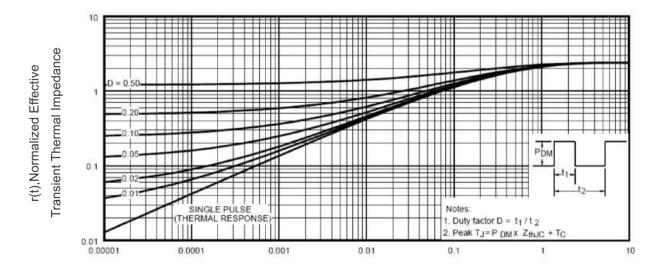
Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



TJ -Junction Temperature(°C)
Figure 9 BVpss vs Junction Temperature



T<sub>J</sub> -Junction Temperature(°C)
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



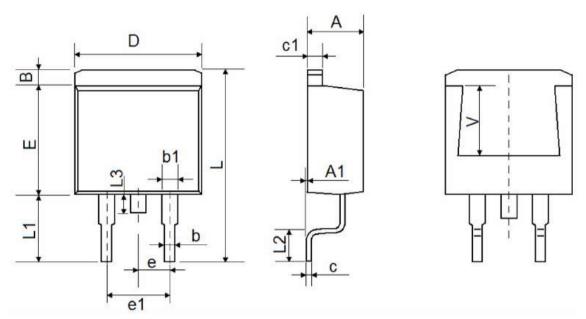
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





# TO-263-2L Package Information



Complete	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	5.600 REF 0.220 REF		REF	



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